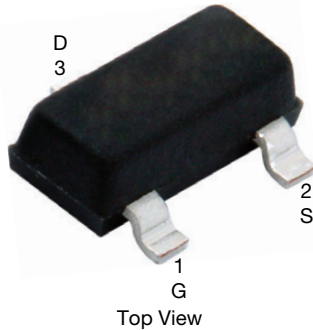


N-Channel 60 V (D-S) MOSFET

SOT-23 (TO-236)

Marking code: 7K

| PRODUCT SUMMARY | |
|---|--------|
| V_{DS} (V) | 60 |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = 10$ V | 2 |
| Q_g typ. (nC) | 0.4 |
| I_D (mA) | 300 |
| Configuration | Single |

FEATURES

- Low on-resistance: 2Ω
- Low threshold: 2 V (typ.)
- Low input capacitance: 25 pF
- Fast switching speed: 25 ns
- Low input and output leakage
- TrenchFET® power MOSFET
- 2000 V ESD protection
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


Note

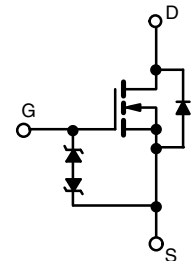
* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

BENEFITS

- Low offset voltage
- Low voltage operation
- Easily driven without buffer
- High speed circuits
- Low error voltage

APPLICATIONS

- Direct logic-level interface: TTL/CMOS
- Drivers: relays, solenoids, lamps, hammers, display, memories, transistors, etc.
- Battery operated systems
- Solid state relays



N-Channel MOSFET

| ORDERING INFORMATION | |
|---------------------------------|----------------|
| Package | SOT-23 |
| Lead (Pb)-free | 2N7002K-T1-E3 |
| Lead (Pb)-free and halogen-free | 2N7002K-T1-GE3 |

| ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ }^\circ\text{C}$, unless otherwise noted) | | | |
|--|----------------|------------------------------------|---------------------------|
| PARAMETER | SYMBOL | LIMIT | UNIT |
| Drain-source voltage | V_{DS} | 60 | V |
| Gate-source voltage | V_{GS} | ± 20 | |
| Continuous drain current ($T_J = 150 \text{ }^\circ\text{C}$) ^b | I_D | $T_A = 25 \text{ }^\circ\text{C}$ | 300 |
| | | $T_A = 100 \text{ }^\circ\text{C}$ | 190 |
| Pulsed drain current ^a | I_{DM} | 800 | mA |
| Power dissipation ^b | P_D | $T_A = 25 \text{ }^\circ\text{C}$ | 0.35 |
| | | $T_A = 100 \text{ }^\circ\text{C}$ | 0.14 |
| Maximum junction-to-ambient ^b | R_{thJA} | 350 | $^\circ\text{C}/\text{W}$ |
| Operating junction and storage temperature range | T_J, T_{stg} | -55 to +150 | $^\circ\text{C}$ |

Notes

- Pulse width limited by maximum junction temperature
- Surface mounted on FR4 board



| SPECIFICATIONS (T _A = 25 °C, unless otherwise noted) | | | | | | |
|---|---------------------|---|--------|-------------------|--------|------|
| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNIT |
| | | | MIN. | TYP. ^a | MAX. | |
| Static | | | | | | |
| Drain-source breakdown voltage | V _{DS} | V _{GS} = 0 V, I _D = 10 μA | 60 | - | - | V |
| Gate-threshold voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 1 | - | 2.5 | |
| Gate-body leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = ± 20 V | - | - | ± 10 | μA |
| | | V _{DS} = 0 V, V _{GS} = ± 15 V | - | - | 1 | |
| | | V _{DS} = 0 V, V _{GS} = ± 10 V | - | - | ± 150 | nA |
| | | V _{DS} = 0 V, V _{GS} = ± 10 V, T _J = 85 °C | - | - | ± 1000 | |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 60 V, V _{GS} = 0 V | - | - | 1 | μA |
| | | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C | - | - | 500 | |
| On-state drain current ^b | I _{D(on)} | V _{GS} = 10 V, V _{DS} = 7.5 V | 800 | - | - | mA |
| | | V _{GS} = 4.5 V, V _{DS} = 10 V | 500 | - | - | |
| Drain-source on-resistance ^b | R _{DS(on)} | V _{GS} = 10 V, I _D = 500 mA | - | - | 2 | Ω |
| | | V _{GS} = 4.5 V, I _D = 200 mA | - | - | 4 | |
| Forward transconductance ^b | g _{fs} | V _{DS} = 10 V, I _D = 200 mA | 100 | - | - | mS |
| Diode forward voltage | V _{SD} | I _S = 200 mA, V _{GS} = 0 V | - | - | 1.3 | V |
| Dynamic ^{a, b} | | | | | | |
| Total gate charge | Q _g | V _{DS} = 10 V, V _{GS} = 4.5 V I _D ≅ 250 mA | - | 0.4 | 0.6 | nC |
| Input capacitance | C _{iss} | V _{DS} = 25 V, V _{GS} = 0 V f = 1 MHz | - | 30 | - | pF |
| Output capacitance | C _{oss} | | - | 6 | - | |
| Reverse transfer capacitance | C _{rss} | | - | 2.5 | - | |
| Switching ^{a, c} | | | | | | |
| Turn-on time | t _{d(on)} | V _{DD} = 30 V, R _L = 150 Ω I _D ≅ 200 mA, V _{GEN} = 10 V, R _g = 10 Ω | - | - | 25 | ns |
| Turn-off time | t _{d(off)} | | - | - | 35 | |

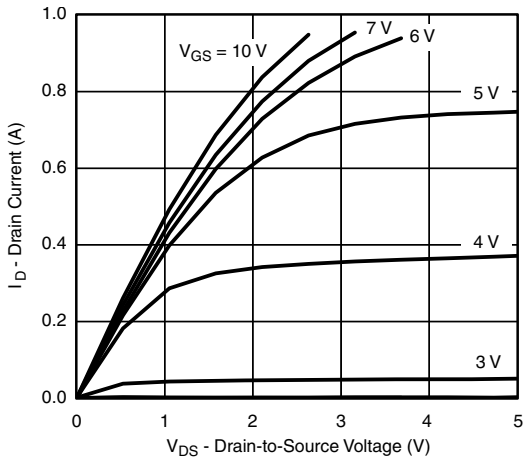
Notes

- a. For DESIGN AID ONLY, not subject to production testing
- b. Pulse test: pulse width ≤ 300 μs duty cycle ≤ 2 %
- c. Switching time is essentially independent of operating temperature

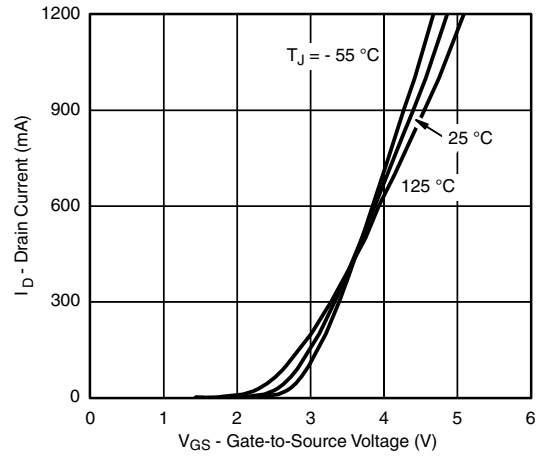
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



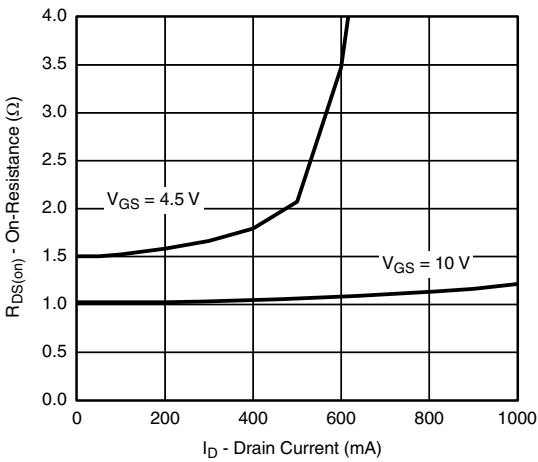
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



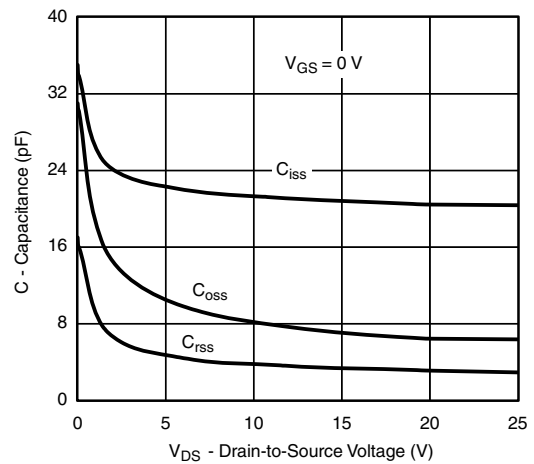
Output Characteristics



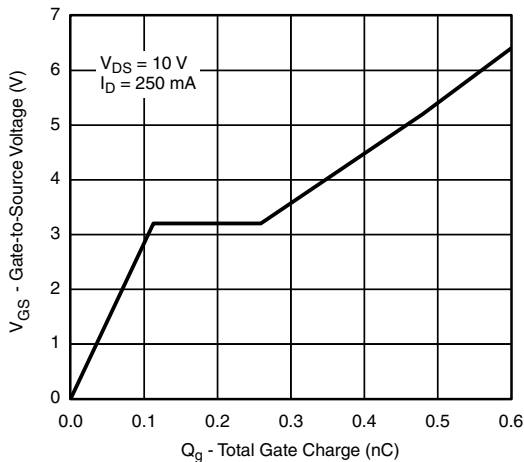
Transfer Characteristics



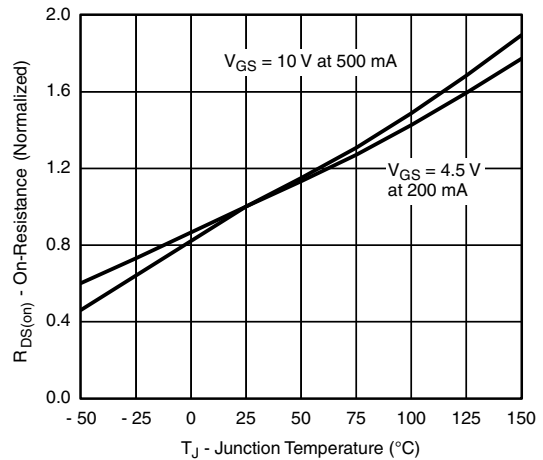
On-Resistance vs. Drain Current



Capacitance



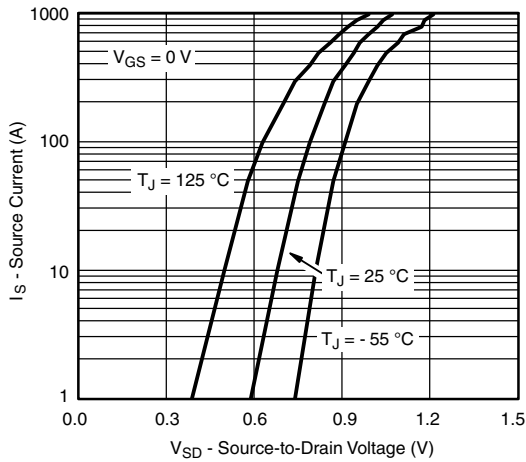
Gate Charge



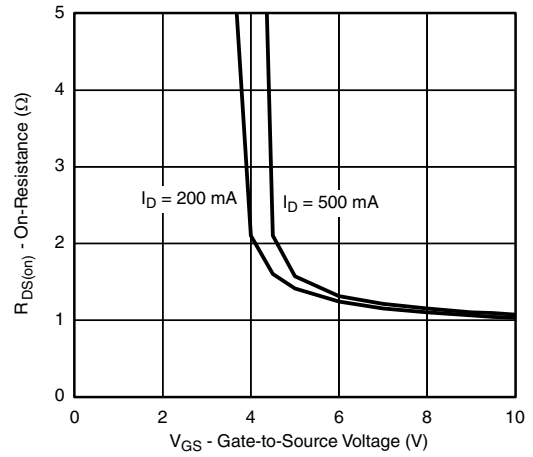
On-Resistance vs. Junction Temperature



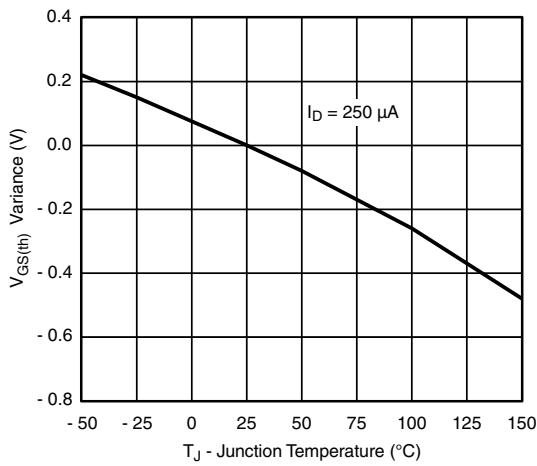
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



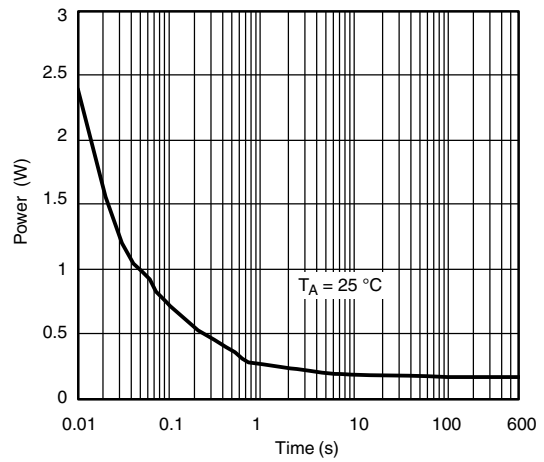
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-Source Voltage



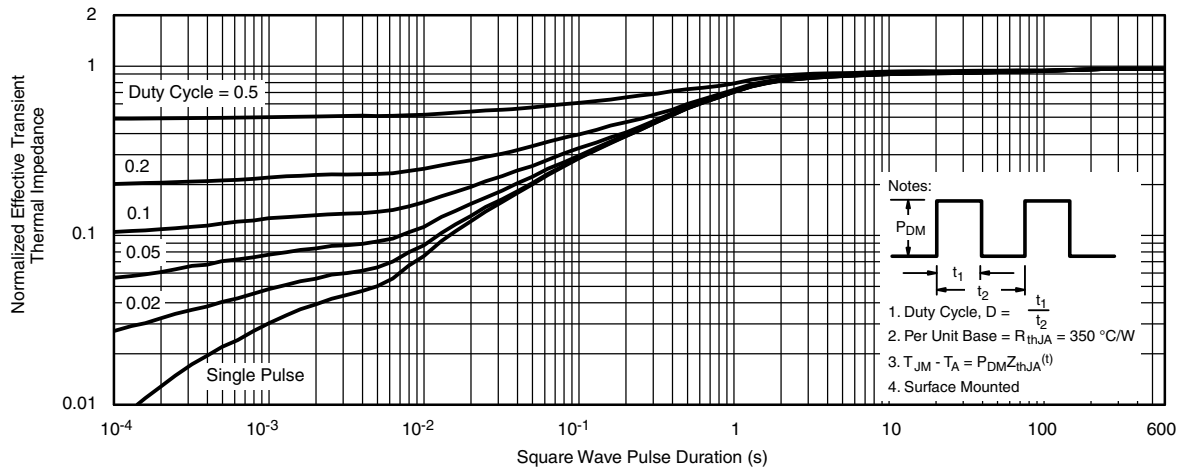
Threshold Voltage Variance Over Temperature



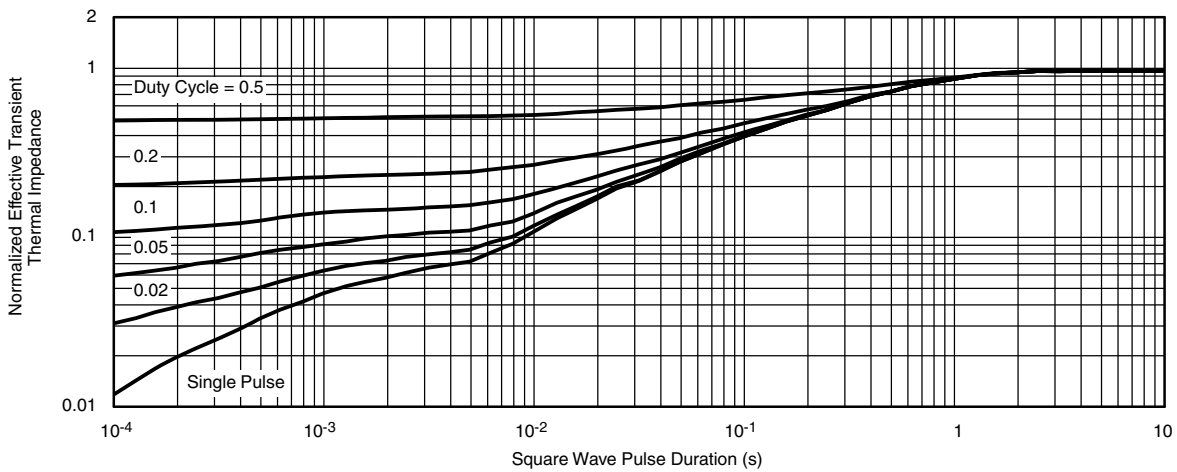
Single Pulse Power, Junction-to-Ambient



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71333.

SOT-23 (TO-236): 3-LEAD



| Dim | MILLIMETERS | | INCHES | |
|----------------|-------------|------|------------|-------|
| | Min | Max | Min | Max |
| A | 0.89 | 1.12 | 0.035 | 0.044 |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 |
| b | 0.35 | 0.50 | 0.014 | 0.020 |
| c | 0.085 | 0.18 | 0.003 | 0.007 |
| D | 2.80 | 3.04 | 0.110 | 0.120 |
| E | 2.10 | 2.64 | 0.083 | 0.104 |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 |
| e | 0.95 BSC | | 0.0374 Ref | |
| e ₁ | 1.90 BSC | | 0.0748 Ref | |
| L | 0.40 | 0.60 | 0.016 | 0.024 |
| L ₁ | 0.64 Ref | | 0.025 Ref | |
| S | 0.50 Ref | | 0.020 Ref | |
| q | 3° | 8° | 3° | 8° |

ECN: S-03946-Rev. K, 09-Jul-01
 DWG: 5479

Mounting LITTLE FOOT[®] SOT-23 Power MOSFETs

Wharton McDaniel

Surface-mounted LITTLE FOOT power MOSFETs use integrated circuit and small-signal packages which have been modified to provide the heat transfer capabilities required by power devices. Leadframe materials and design, molding compounds, and die attach materials have been changed, while the footprint of the packages remains the same.

See Application Note 826, *Recommended Minimum Pad Patterns With Outline Drawing Access for Vishay Siliconix MOSFETs*, (<http://www.vishay.com/doc?72286>), for the basis of the pad design for a LITTLE FOOT SOT-23 power MOSFET footprint. In converting this footprint to the pad set for a power device, designers must make two connections: an electrical connection and a thermal connection, to draw heat away from the package.

The electrical connections for the SOT-23 are very simple. Pin 1 is the gate, pin 2 is the source, and pin 3 is the drain. As in the other LITTLE FOOT packages, the drain pin serves the additional function of providing the thermal connection from the package to the PC board. The total cross section of a copper trace connected to the drain may be adequate to carry the current required for the application, but it may be inadequate thermally. Also, heat spreads in a circular fashion from the heat source. In this case the drain pin is the heat source when looking at heat spread on the PC board.

Figure 1 shows the footprint with copper spreading for the SOT-23 package. This pattern shows the starting point for utilizing the board area available for the heat spreading copper. To create this pattern, a plane of copper overlies the drain pin and provides planar copper to draw heat from the drain lead and start the process of spreading the heat so it can be dissipated into the

ambient air. This pattern uses all the available area underneath the body for this purpose.



FIGURE 1. Footprint With Copper Spreading

Since surface-mounted packages are small, and reflow soldering is the most common way in which these are affixed to the PC board, “thermal” connections from the planar copper to the pads have not been used. Even if additional planar copper area is used, there should be no problems in the soldering process. The actual solder connections are defined by the solder mask openings. By combining the basic footprint with the copper plane on the drain pins, the solder mask generation occurs automatically.

A final item to keep in mind is the width of the power traces. The absolute minimum power trace width must be determined by the amount of current it has to carry. For thermal reasons, this minimum width should be at least 0.020 inches. The use of wide traces connected to the drain plane provides a low-impedance path for heat to move away from the device.

RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads
Dimensions in Inches/(mm)

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